TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type

SSM3J115TU

High-Speed Switching Applications

Power Management Switch Applications

- 1.5 V drive
- Low ON-resistance:

 $R_{on} = 353 \text{ m}\Omega \text{ (max)} (@V_{GS} = -1.5 \text{ V})$ $R_{on} = 193 \text{ m}\Omega \text{ (max)} (@V_{GS} = -1.8 \text{ V})$ $R_{on} = 125 \text{ m}\Omega \text{ (max)} (@V_{GS} = -2.5 \text{ V})$ $R_{on} = 98 \text{ m}\Omega \text{ (max)} (@V_{GS} = -4.0 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

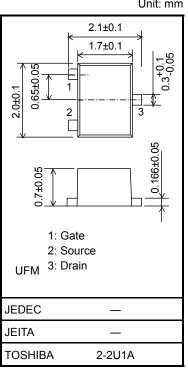
Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V _{DS}	-20	V	
Gate-source voltage		V _{GSS}	± 8	V	
Drain current	DC	I _D	-2.2	A	
Dialiticultent	Pulse	I _{DP}	-4.4		
Drain power dissipation		PD (Note 1)	800	mW	
		PD (Note 2)	500		
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on a ceramic board. $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 0.8 \text{ mm}, \text{Cu Pad: } 645 \text{ mm}^2)$ Note 2: Mounted on an FR4 board.

(25.4 mm × 25.4 mm × 1.6 mm, Cu Pad: 645 mm²)



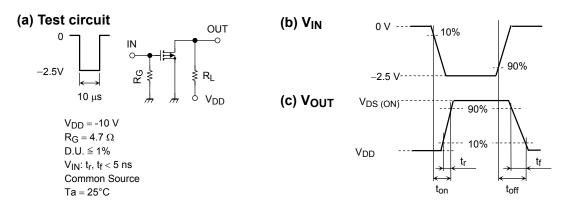
Weight: 6.6 mg (typ.)

Charao	cteristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-20		_	V
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = +8 \text{ V}$	-12			v
Drain cutoff curre	nt	I _{DSS}	$V_{DS}=-20~V,~V_{GS}=0$	—		-10	μA
Gate leakage curr	rent	I _{GSS}	$V_{GS}=\pm 8~V,~V_{DS}=0$	_	_	±1	μA
Gate threshold vo	ltage	V _{th}	$V_{DS}=-3~V,~I_D=-1~mA$	-0.3	_	-1.0	V
Forward transfer a	admittance	Y _{fs}	$V_{DS} = -3 V, I_D = -0.9 A$ (Note 3)	2.7	5.4	_	S
Drain-source ON-resistance		R _{DS} (ON)	$I_D = -1.0 \text{ A}, V_{GS} = -4.0 \text{ V}$ (Note 3)	_	77	98	mΩ
			$I_D = -1.0 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note 3)		84	125	
			$I_D = -1.0 \text{ A}, V_{GS} = -1.8 \text{ V}$ (Note 3)	_	111	193	
			$I_D = -0.1 \text{ A}, V_{GS} = -1.5 \text{ V}$ (Note 3)		126	353	
Input capacitance		C _{iss}	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ MHz}$	_	568	_	pF
Output capacitand	ce	Coss	$V_{DS} = -10 V, V_{GS} = 0, f = 1 MHz$	_	75	_	pF
Reverse transfer	capacitance	C _{rss}	$V_{DS} = -10$ V, $V_{GS} = 0$, f = 1 MHz	—	67		pF
Switching time	Turn-on time	t _{on}	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -0.9 \text{ A}, \\ V_{GS} = 0 -2.5 \text{ V}, \text{ R}_{G} = 4.7 \Omega$	_	29	_	ns
	Turn-off time	t _{off}		_	39	_	
Drain-source forw	ard voltage	V _{DSF}	$I_D = 2.2 \text{ A}, V_{GS} = 0 \text{ V}$ (Note 3)	_	0.8	1.2	V

Electrical Characteristics (Ta = 25°C)

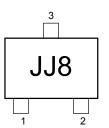
Unit: mm

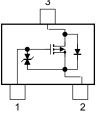
Switching Time Test Circuit



Marking

Equivalent Circuit (top view)





Precaution

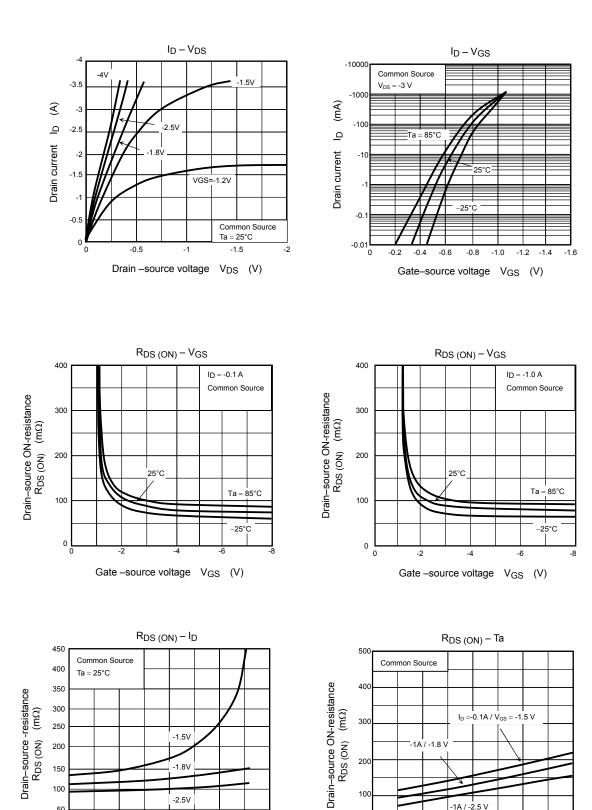
 V_{th} can be expressed as the voltage between gate and source when the low operating current value is $I_D = -1$ mA for this product. For normal switching operation, $V_{GS (on)}$ requires a higher voltage than V_{th} , and $V_{GS (off)}$ requires a lower voltage than V_{th} .

(The relationship can be established as follows: $V_{GS (off)} < V_{th} < V_{GS (on).}$) Take this into consideration when using the device.

Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

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100

-1

-2.5V

-3

-4

-2

Drain current ID (A)

150

3

100

0

-50

-1A / -2.5 V

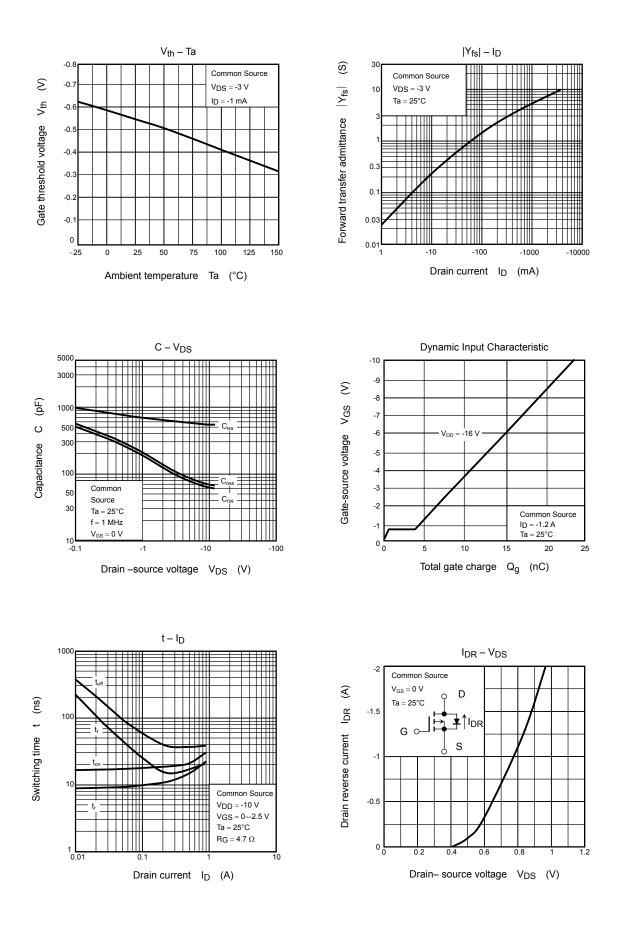
50

Ambient temperature Ta (°C)

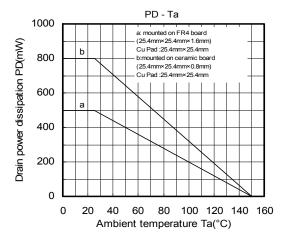
0

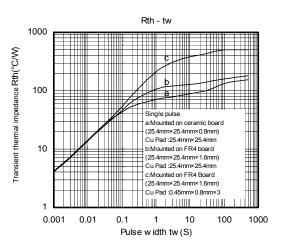
100

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20070701-EN GENERAL

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